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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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# P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

### **DESCRIPTION**

The  $\mu$ PA1910 is a switching device which can be driven directly by a 2.5-V power source.

The  $\mu$ PA1910 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

### **FEATURES**

- Can be driven by a 2.5-V power source
- · Low on-state resistance

 $R_{DS(on)1} = 80 \text{ m}\Omega \text{ MAX.}$  (Vgs = -4.5 V, ID = -1.5 A)

 $R_{DS(on)2} = 90 \text{ m}\Omega$  MAX. (Vgs = -4.0 V, ID = -1.5 A)

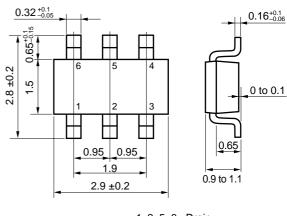
 $R_{DS(on)3}$  = 100  $m\Omega$  MAX. (Vgs = -3.0 V, Ip = -1.0 A)

 $R_{DS(on)4} = 130 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = -2.5 \text{ V, Ip} = -1.0 \text{ A)}$ 

### ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1910TE	SC-95 (Mini Mold Thin Type)

### PACKAGE DRAWING (Unit: mm)

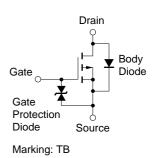


1, 2, 5, 6 : Drain 3 : Gate 4 : Source

### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	VDSS	-12	V
Gate to Source Voltage	Vgss	-10/+5	V
Drain Current (DC)	ID(DC)	±2.5	Α
Drain Current (pulse) Note1	D(pulse)	±10	Α
Total Power Dissipation	P <sub>T1</sub>	0.2	W
Total Power Dissipation Note2	P <sub>T2</sub>	2	W
Channel Temperature	Tch	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

### **EQUIVALENT CIRCUIT**



**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

2. Mounted on FR-4 board,  $t \le 5$  sec.

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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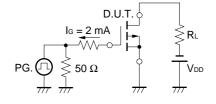
### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V <sub>DS</sub> = -12 V, V <sub>GS</sub> = 0 V			-10	μΑ
Gate Leakage Current	lgss	Vgs = ±10 V, Vps = 0 V			±10	μΑ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$	-0.4	-0.72	-1.5	V
Forward Transfer Admittance	<b>y</b> fs	$V_{DS} = -10 \text{ V}, I_{D} = -1.5 \text{ A}$	1	5.1		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = -4.5 V, ID = -1.5 A		60	80	mΩ
	RDS(on)2	Vgs = -4.0 V, ID = -1.5 A		63	90	mΩ
	R <sub>DS(on)3</sub>	Vgs = -3.0 V, ID = -1.0 A		75	100	mΩ
	R <sub>DS(on)4</sub>	Vgs = -2.5 V, ID = -1.0 A		86	130	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		386		pF
Output Capacitance	Coss	V <sub>G</sub> S = 0 V		283		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		154		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = -10 V		131		ns
Rise Time	tr	ID = -1.5 A		603		ns
Turn-off Delay Time	t <sub>d(off)</sub>	$V_{GS(on)} = -4.0 \text{ V}$		427		ns
Fall Time	tf	$R_G = 10 \Omega$		1470		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = −10 V		6.7		nC
Gate to Source Charge	Qgs	lo = -3.0 A		1.6		nC
Gate to Drain Charge	Q <sub>GD</sub>	V <sub>GS</sub> = -4.0 V		2.9		nC
Diode Forward Voltage	VF(S-D)	IF = 2.5 A, Vgs = 0 V		0.74		V
Reverse Recovery Time	trr	IF = 2.5 A, VGS = 0 V		30.0		ns
Reverse Recovery Charge	Qrr	$di/dt = 10 A/\mu s$		2.2		nC

### **TEST CIRCUIT 1 SWITCHING TIME**

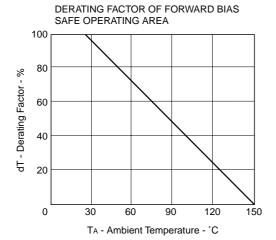
# PG. $\bigcap_{R_G} R_G = 10 \Omega$ $\tau = 1 \mu \text{ s}$ Duty Cycle $\leq 1 \%$

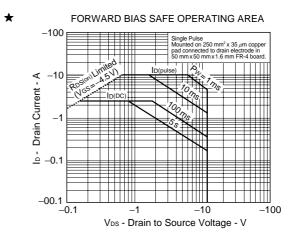
### **TEST CIRCUIT 2 GATE CHARGE**

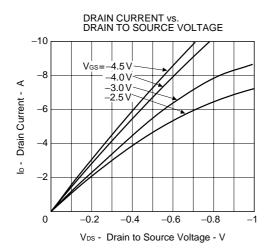


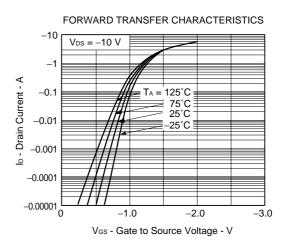


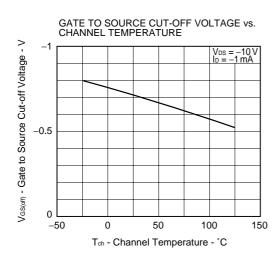
### TYPICAL CHARCTERISTICS (TA = 25 °C)

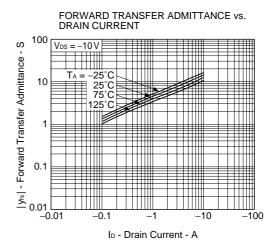


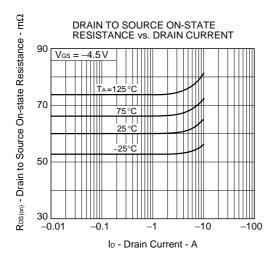


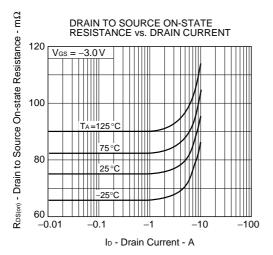


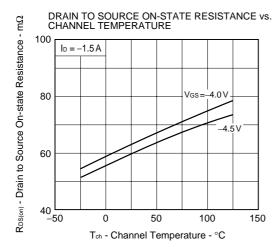


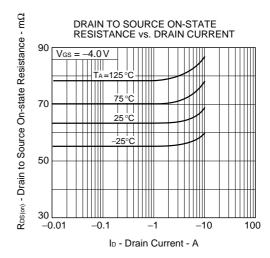


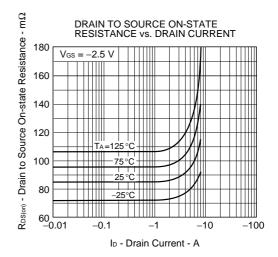


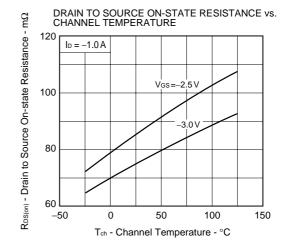


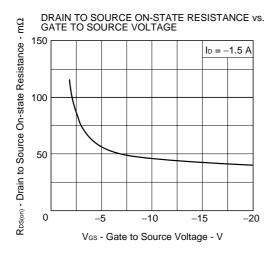


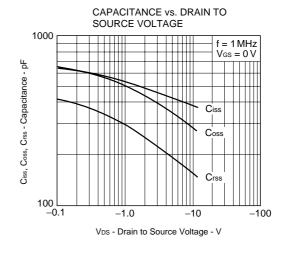


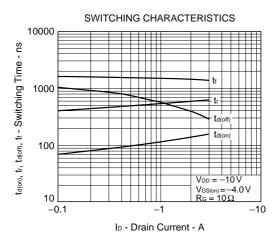


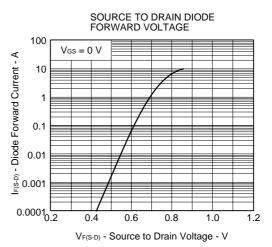


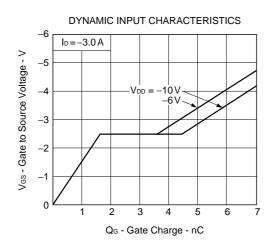




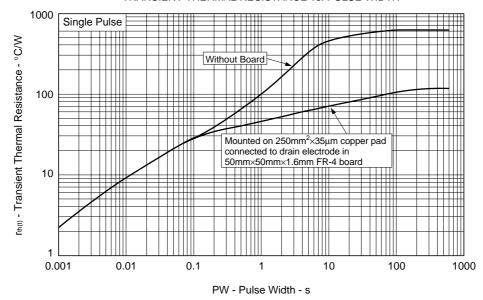








### ★ TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



[MEMO]



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